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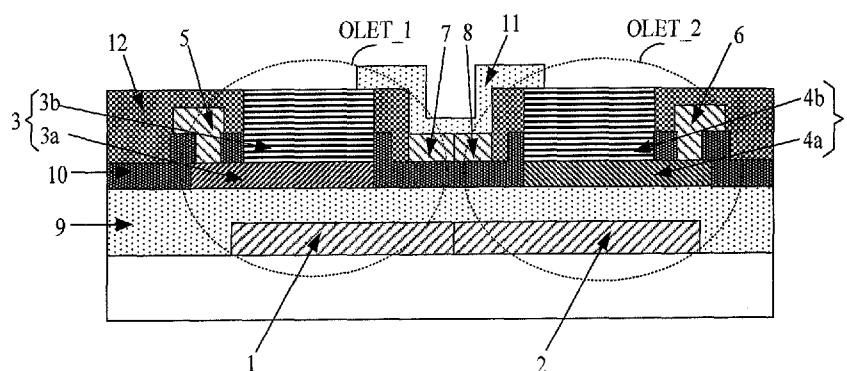


Fig. 5

(57) Abstract: The present disclosure relates to an organic luminescent substrate. The organic luminescent substrate may include a first organic luminescent field effect transistor and a second organic luminescent field effect transistor. The first organic luminescent field effect transistor may include a first gate electrode, a first electrode, a second electrode, and a first active luminescent layer. The second organic luminescent field effect transistor may include a second gate electrode, a third electrode, a fourth electrode, and a second active luminescent layer. One of the first organic luminescent field effect transistor and the second organic luminescent field effect transistor may be an N-type transistor and the other one may be a P-type transistor. The first gate electrode may be coupled to the second gate electrode.



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**ORGANIC LUMINESCENT SUBSTRATE, PREPARATION METHOD THEREOF,
DISPLAY APPARATUS, AND DISPLAY DRIVING METHOD**

CROSS-REFERENCE TO RELATED APPLICATIONS

[0001] This application claims benefit of the filing date of Chinese Patent Application No. 201711320689.6 filed on December 12, 2017, the disclosure of which is hereby incorporated in its entirety by reference.

TECHNICAL FIELD

[0002] The present disclosure relates to display technology, and particularly to an organic luminescent substrate, a preparation method thereof, a display apparatus, and a display driving method.

BACKGROUND

[0003] The Field Effect Transistor (FET) is widely regarded by researchers because of its low cost, compatibility with flexible substrates and wide source of materials. Furthermore, the Organic Luminescent Transistor (OLET) combines the driving function of the FET and the luminescence function of Organic Luminescent Diode (OLED). The Organic Luminescent Transistor (OLET) possesses electroluminescence characteristics and has excellent application prospect in the field of display technology.

BRIEF SUMMARY

[0004] One example of the present disclosure provides an organic luminescent substrate. The organic luminescent substrate may include a first organic luminescent field effect transistor and a second organic luminescent field effect transistor. The first organic luminescent field effect transistor may include a first gate electrode, a first electrode, a second electrode, and a first active luminescent layer. The second organic luminescent field effect transistor may include a second gate electrode, a third electrode, a fourth electrode, and a second active luminescent layer. One of the first organic luminescent field effect transistor and the second organic luminescent

1 field effect transistor is an N-type transistor and the other one is a P-type transistor. The first gate
2 electrode is coupled to the second gate electrode.

3 **[0005]** Optionally, the second electrode is coupled to the fourth electrode, the first
4 electrode and the second electrode are both coupled to the first active luminescent layer, and the
5 third electrode and the fourth electrode are both coupled to the second active luminescent layer.

6 **[0006]** Optionally, the first active luminescent layer comprises a first organic
7 luminescent semiconductor material; the second active luminescent layer comprises a second
8 organic luminescent semiconductor material; one of the first organic luminescent semiconductor
9 material and the second organic luminescent semiconductor material is an N type organic
10 luminescent semiconductor material, and the other one is a P type organic luminescent
11 semiconductor material.

12 **[0007]** Optionally, the first active luminescent layer comprises a first active layer and a
13 first luminescent layer on a side of the first active layer; the second active luminescent layer
14 comprises a second active layer and a second luminescent layer on a side of the second active
15 layer; and the first active layer and the second active layer are in a same layer, and the first
16 luminescent layer and the second luminescent layer are in a same layer.

17 **[0008]** Optionally, an orthographic projection of the first luminescent layer on a plane
18 where the first active layer is located covers a partial region of the first active layer, the first
19 electrode is coupled to a region on a side of the first active layer opposite from the base substrate
20 and not covered by the first luminescent layer, and an orthographic projection of the first
21 electrode on the plane where the first active layer is located does not overlap an orthographic
22 projection of the first luminescent layer on the plane where the first active layer is located. An
23 orthographic projection of the second luminescent layer on a plane where the second active layer
24 is covers a partial region of the second active layer, the third electrode is coupled to a region on a
25 side of the second active layer opposite from the base substrate and not covered by the second
26 luminescent layer, and an orthographic projection of the third electrode on the plane where the
27 second active layer is does not overlap the orthographic projection of second luminescent layer
28 on the plane where the second active layer is.

1 **[0009]** Optionally, an orthographic projection of the second electrode on a plane where
2 the first active luminescent layer is located does not overlap the first active luminescent layer. An
3 orthographic projection of the fourth electrode on a plane where the second active luminescent
4 layer is does not overlap the second active luminescent layer.

5 **[0010]** Optionally, the organic luminescent substrate further includes a transparent
6 electrode. The transparent electrode couples the first active luminescent layer with the second
7 electrode, and couples the second active luminescent layer with the fourth electrode.

8 **[0011]** Optionally, the first active luminescent layer and the second active luminescent
9 layer are configured to emit light of different colors in a conductive state.

10 **[0012]** Optionally, the first electrode and the second electrode each have a comb shape
11 comprising a comb tooth portion, an orthographic projection of the comb tooth portion of the
12 first electrode on a plane where the first gate electrode is and an orthographic projection of the
13 comb tooth portion of the second electrode on the plane where the first gate electrode is are
14 alternately disposed. The third electrode and the fourth electrode each have a comb shape
15 comprising a comb tooth portion, an orthographic projection of the comb tooth portion of the
16 third electrode on a plane where the second gate electrode is and an orthographic projection of
17 the comb tooth portion of the fourth electrode on the plane where the second gate electrode is
18 are alternately disposed.

19 **[0013]** Optionally, the first electrode is electrically coupled to the third electrode.

20 **[0014]** Another example of the present disclosure provides a method of preparing an
21 organic luminescent substrate. The method may include forming patterns of a first gate electrode
22 and a second gate electrode on a base substrate, the first gate electrode and the second gate
23 electrode being electrically coupled; forming a gate electrode insulating layer on a side of the
24 first gate electrode and the second gate electrode opposite from the base substrate; forming
25 patterns of the first active luminescent layer and the second active luminescent layer on a side of
26 the gate electrode insulating layer opposite from the base substrate; and forming patterns of a
27 first electrode, a second electrode, a third electrode, and a four-electrode on a side of the first

1 active luminescent layer and the second active luminescent layer opposite from the base
2 substrate.

3 **[0015]** Optionally, forming the patterns of the first active luminescent layer and the
4 second active luminescent layer on the side of the gate electrode insulating layer opposite from
5 the base substrate comprises forming patterns of a first active layer and a second active layer on
6 the side of the gate electrode insulating layer opposite from the base substrate by one patterning
7 process; performing N-type doping on one of the first active layer and the second active layer,
8 and performing P-type doping on the other one thereof; and forming a pattern of the first
9 luminescent layer on a side of the first active layer opposite from the base substrate and a pattern
10 of the second luminescent layer on a side of the second active layer opposite from the base
11 substrate.

12 **[0016]** Optionally, forming the patterns of the first active luminescent layer and the
13 second active luminescent layer on the side of the gate electrode insulating layer opposite from
14 the base substrate comprises forming patterns of a first active layer and a second active layer on
15 a side of the gate electrode insulating layer opposite from the base substrate; performing N-type
16 doping on one of the first active layer and the second active layer, performing P-type doping on
17 the other one thereof; forming an interlayer insulating layer on a side of the first active layer and
18 the second active layer opposite from the base substrate, forming a first through hole and a
19 second through hole respectively in regions of the interlayer insulating layer corresponding to the
20 first electrode and the third electrode formed subsequently; and forming a first electrode, a
21 second electrode, a third electrode, and a fourth electrode on a side of the interlayer insulating
22 layer opposite from the base substrate. The first electrode is coupled to the first active layer
23 through the first through hole, the third electrode is coupled to the second active layer through
24 the second through hole; an orthographic projection of the second electrode and the fourth
25 electrode on a plane where the first active layer is does not overlap the orthographic projection of
26 first luminescent layer and the second luminescent layer formed subsequently on the plane where
27 the first active layer is, and the second electrode is electrically coupled to the fourth electrode.

1 **[0017]** Optionally, forming patterns of the first electrode, the second electrode, the third
2 electrode, and the a four-electrode on the side of the first active luminescent layer and the second
3 active luminescent layer opposite from the base substrate comprises forming a transparent
4 electrode, the transparent electrode coupling the first active luminescent layer with the second
5 electrode as well as coupling the second active luminescent layer with the fourth electrode.

6 **[0018]** Optionally, the method of preparing an organic luminescent substrate may further
7 include forming a pixel defining layer on a side of the interlayer insulating layer opposite from
8 the base substrate. A region of the pixel defining layer on the first active layer and a region of the
9 pixel defining layer on the second active layer are provided with a third through hole and a
10 fourth through hole respectively.

11 **[0019]** Optionally, the method of preparing an organic luminescent substrate may further
12 include forming the first luminescent layer and the second luminescent layer respectively in the
13 third through hole and the fourth through hole; and forming a transparent electrode on a side of
14 the pixel defining layer opposite from the base substrate, the transparent electrode coupling the
15 first luminescent layer with the second electrode as well as coupling the second luminescent
16 layer with the fourth electrode.

17 **[0020]** Another example of the present disclosure is a display apparatus. The display
18 apparatus may include the organic luminescent substrate according to one embodiment of the
19 present disclosure.

20 **[0021]** Optionally, the display apparatus may further include a plurality of gate lines and
21 a plurality of data lines, the plurality of the gate lines and the plurality of the data lines defining a
22 plurality of display areas arranged in an array, and the organic luminescent substrate has a one-
23 to-one correspondence with each of the plurality of the display areas, each of the plurality of the
24 display areas comprising a first sub-pixel region and a second sub-pixel region, the first organic
25 luminescent field effect transistor is located in the corresponding first sub-pixel region, and the
26 second organic luminescent field effect transistor is located in the corresponding second sub-
27 pixel region.

1 **[0022]** Optionally, the display apparatus may further include a switching transistor. The
2 switching transistor has a one-to-one correspondence with the organic luminescent apparatus, a
3 gate electrode of the switching transistor is coupled to a corresponding one of the plurality of the
4 gate lines, a source of the switching transistor is coupled to a corresponding one of the plurality
5 of the data lines, and a drain of the switching transistor is coupled to the first gate electrode and
6 the second gate electrode of the corresponding organic luminescent apparatus.

7 **[0023]** Another example of the present disclosure is a display driving method of the
8 display apparatus according to one embodiment of the present disclosure. The display driving
9 method may include inputting scanning signals to each of the gate lines one by one according to
10 a first scanning period. The first scanning period comprises a first half period and a second half
11 period, each of the data lines provides a first type of data voltage in the first half period and a
12 second type of data voltage in the second half period, one of the first type of data voltage and the
13 second type of data voltage is a high level data voltage, and the other one is a low level data
14 voltage.

15 **[0024]** Optionally, each complete picture includes a previous frame and a subsequent
16 frame. The display driving method may include inputting scan signals to each of the gate lines
17 one by one according to a second scan period during a time of displaying the previous frame,
18 wherein the data lines each provide a first type of data voltage in each second scan period;
19 inputting scan signals to each of the gate lines one by one according to the second scan period
20 during a time of displaying the subsequent frame, wherein the data lines each provide a second
21 type of data voltage in each second scan period; and one of the first type of data voltage and the
22 second type of data voltage is a high level data voltage, and the other one thereof is a low level
23 data voltage.

24 **BRIEF DESCRIPTION OF THE DRAWINGS**

25 **[0025]** The subject matter which is regarded as the disclosure is particularly pointed out
26 and distinctly claimed in the claims at the conclusion of the specification. The foregoing and
27 other objects, features, and advantages of the present disclosure are apparent from the following
28 detailed description taken in conjunction with the accompanying drawings in which:

1 **[0026]** Fig. 1 is a schematic cross-sectional view of an organic luminescent substrate
2 according to one embodiment of the present disclosure;

3 **[0027]** Fig. 2 is a schematic circuit diagram of an organic luminescent substrate
4 according to one embodiment of the present disclosure;

5 **[0028]** Fig. 3 is a top view of the first electrode and the second electrode according to
6 one embodiment of the present disclosure;

7 **[0029]** Fig. 4 is a schematic cross-sectional view of an organic luminescent substrate
8 according to one embodiment of the present disclosure;

9 **[0030]** Fig. 5 is a schematic cross-sectional view of an organic luminescent substrate
10 according to one embodiment of the present disclosure; FIG.

11 **[0031]** Fig. 6 is a flow chart of a method of preparing an organic luminescent substrate
12 according to one embodiment of the present disclosure;

13 **[0032]** Figs. 7a to 7c are schematic diagrams of intermediate structures of an organic
14 luminescent substrate prepared by the preparation method according to one embodiment of the
15 present disclosure;

16 **[0033]** Fig. 8 is a flow chart of a method of preparing an organic luminescent substrate
17 according to one embodiment of the present disclosure;

18 **[0034]** Figs. 9a to 9f are schematic diagrams of intermediate structures of an organic
19 luminescent substrate prepared by the preparation method according to one embodiment of the
20 present disclosure;

21 **[0035]** Fig. 10 is a schematic structural diagram of a circuit of a display apparatus
22 according to one embodiment of the present disclosure;

23 **[0036]** Fig. 11 is a schematic view of a structure of a circuit in a display area of Figure 10;

24 **[0037]** Fig. 12a is a schematic diagram of a driving sequence of the display apparatus
25 according to one embodiment of the present disclosure;

1 **[0038]** Fig. 12b is a schematic diagram of a driving sequence of the display apparatus
2 according to one embodiment of the present disclosure.

3 **DETAILED DESCRIPTION**

4 **[0039]** The present disclosure will be described in further detail with reference to the
5 accompanying drawings and embodiments in order to provide a better understanding by those
6 skilled in the art of the technical solutions of the present disclosure. Throughout the description
7 of the disclosure, reference is made to Figs. 1-12b. When referring to the figures, like structures
8 and elements shown throughout are indicated with like reference numerals.

9 **[0040]** Fig. 1 is a schematic cross-sectional view of an organic luminescent substrate
10 according to one embodiment of the present disclosure. FIG. 2 is a schematic circuit diagram of
11 an organic luminescent substrate according to one embodiment of the present disclosure. As
12 shown in Figs. 1 and 2, the organic luminescent substrate includes: a first organic luminescent
13 field effect transistor OLET_1 and a second organic luminescent field effect transistor OLET_2.
14 One of the first organic luminescent field effect transistor OLET_1 and the second organic
15 luminescent field effect transistor OLET_2 is an N type Transistor, and the other one is a P-type
16 transistor.

17 **[0041]** In some embodiments, the first organic luminescent field effect transistor
18 OLET_1 includes: a first gate electrode 1, a first electrode 5, a second electrode 7, and a first
19 active luminescent layer 3. The second organic luminescent field effect transistor OLET_2
20 includes: a second gate electrode 2, a third electrode 6, a fourth electrode 8, and a second active
21 luminescent layer 4. The first gate electrode 1 is coupled to the second gate electrode 2, and the
22 second electrode 7 is coupled to the fourth electrode 8.

23 **[0042]** In the embodiments, one of the first electrode 5 and the second electrode 7 in the
24 first organic luminescent field effect transistor OLET_1 is the source of the transistor and the
25 other one is the drain of the transistor. One of the third electrode 6 and the fourth electrode 8 in
26 the second organic luminescent field effect transistor OLET_2 is the source of the transistor and
27 the other one is the drain of the transistor.

1 **[0043]** In some embodiments, as shown in Fig. 1, the material of the first active
2 luminescent layer 3 includes a first organic luminescent semiconductor material. The material of
3 the second active luminescent layer 4 includes a second organic luminescent semiconductor
4 material. One of the first organic luminescent semiconductor material and the second organic
5 luminescent semiconductor material is an N type organic luminescent semiconductor material,
6 and the other one is a P type organic luminescent semiconductor material.

7 **[0044]** It should be noted that the active luminescent layer in the present disclosure may
8 be directly composed of an organic luminescent semiconductor material (shown in FIG. 1), or an
9 independent organic luminescent layer and an independent active layer, or by doping in the
10 organic luminescent layer to make the organic luminescent layer to have semiconductor
11 characteristics. Of course, the active luminescent layer may further include a transport layer for
12 improving efficiency of carrier (hole, electron) transfer. The technical solution of the present
13 disclosure does not limit the specific structure of the active luminescent layer, but any structure
14 capable of simultaneously providing the functions of the semiconductor layer and the
15 luminescent layer can be used as the active luminescent layer in the present disclosure.

16 **[0045]** For convenience of description, the connection between the first gate electrode 1
17 and the second gate electrode 2 is referred to as a voltage input terminal of the organic
18 luminescent apparatus. When a voltage is input to the input terminal of the voltage input terminal,
19 the input voltage is simultaneously transmitted to the first gate electrode 1 and the second gate
20 electrode 2.

21 **[0046]** In the present disclosure, the voltage input by the voltage input terminal can be
22 divided into two types: a high level voltage and a low level voltage. The high-level voltage refers
23 to a voltage capable of turning on the N-type transistor in the organic luminescent substrate and
24 turning off the P-type transistor, and the low-level voltage specifically refers to a voltage capable
25 of turning on the P-type transistor and turning off the N-type transistor in the organic
26 luminescent apparatus. The specific ranges of the values of the high-level voltage and the low-
27 level voltage are determined by the voltages to which the first electrode 5, the second electrode 7
28 (the fourth electrode 8), and the third electrode 6 are connected.

1 **[0047]** In the organic luminescent substrate provided by embodiments of the present
2 disclosure, when the voltage input terminal inputs a high-level voltage, the N-type transistor is
3 turned on and the P-type transistor is turned off. When the voltage input terminal inputs a low-
4 level voltage, the P-type transistor is turned on and the N-type transistor is turned off. It can be
5 seen that, regardless of the high-level voltage or the low-level voltage input by the voltage input
6 terminal, only one of the first organic luminescent field effect transistor OLET_1 and the second
7 organic luminescent field effect transistor OLET_2 is turned on and emits light. The other one is
8 turned off and does not emit light. Thus, the organic luminescent substrate provided by
9 embodiments of the present disclosure can control two different organic luminescent field effect
10 transistors to emit light respectively through one voltage input terminal, thereby simplifying
11 circuit complexity.

12 **[0048]** In order to facilitate the understanding of the present disclosure by those skilled in
13 the art, an exemplary description will be made by taking the first organic luminescent field effect
14 transistor OLET_1 as an N-type transistor and the second organic luminescent field effect
15 transistor OLET_2 as a P-type transistor as an example.

16 **[0049]** In some embodiments, in operation, the first electrode 5 is coupled to the first
17 working voltage V_{ss} , the second electrode 7 (fourth electrode 8) is coupled to the second
18 working voltage V_{dd} , and the third electrode is coupled to the third working voltage V_{ss}' ,
19 wherein $V_{ss} > V_{dd} > V_{ss}'$. At this time, the first electrode 5 and the third electrode 6 are both
20 sources, and the second electrode 7 and the fourth electrode 8 are both drains. Correspondingly,
21 the high-level voltage refers to a voltage whose voltage value is greater than $V_{dd} + V_{th_N}$, and
22 the low-level voltage refers to a voltage whose voltage value is less than $V_{dd} + V_{th_P}$. V_{th_N} is a
23 threshold voltage of the first organic luminescent field effect transistor OLET_1, and the value
24 thereof is generally positive. V_{th_P} is a threshold voltage of the second organic luminescent field
25 effect transistor OLET_2, and the value thereof is generally negative. In practical applications,
26 the specific values of V_{ss} , V_{dd} , and V_{ss}' can be adjusted based on threshold voltages and sub-
27 threshold swing characteristics of the first organic luminescent field effect transistor OLET_1
28 and the second organic luminescent field effect transistor OLET_2.

1 **[0050]** When the voltage input terminal inputs a high-level voltage, the first organic
2 luminescent field effect transistor OLET_1 emits light, and the second organic luminescent field
3 effect transistor OLET_2 does not emit light. By adjusting the magnitude of the high-level
4 voltage, the brightness of the first organic luminescent field effect transistor OLET_1 can be
5 adjusted. When the voltage input terminal inputs a low-level voltage, the second organic
6 luminescent field effect transistor OLET_2 emits light, and the first organic luminescent field
7 effect transistor OLET_1 does not emit light. By adjusting the magnitude of the low-level
8 voltage, the brightness of the second organic luminescent field effect transistor OLET_2 can be
9 adjusted.

10 **[0051]** In some embodiments, the threshold voltages of the first organic luminescent field
11 effect transistor OLET_1 and the second organic luminescent field effect transistor OLET_2 can
12 also be accurately set, so that when the voltage input terminal inputs a certain voltage, the first
13 organic luminescent field effect transistor OLET_1 and the second organic luminescent field
14 effect transistor OLET_2 can emit light at exactly the same time.

15 **[0052]** In addition, that the first organic luminescent field effect transistor OLET_1 is an
16 N-type transistor, the second organic luminescent field effect transistor OLET_2 is a P-type
17 transistor, and $V_{ss} > V_{dd} > V_{ss}'$ is only an exemplary situation, and the embodiments of the
18 present disclosure are not limited to the above situation.

19 **[0053]** For example, in some embodiments, $V_{ss} = V_{ss}' > V_{dd}$, at which time the second
20 electrode 7 and the third electrode 6 serve as sources, and the first electrode 5 and the fourth
21 electrode 8 serve as drains. Other situations will not be described here.

22 **[0054]** In one embodiment, the first active luminescent layer 3 and the second active
23 luminescent layer 4 emit different colors of light when in a conductive state, that is, the organic
24 luminescent substrate can emit light of two different colors, thereby enhancing color gamut of
25 organic luminescent apparatus.

26 **[0055]** In some embodiments, the shapes of the first electrode 5 and the second electrode
27 7 are both comb-shaped. The orthographic projection of the comb tooth portion 5a of the first

electrode 5 and the orthographic projection of the comb tooth portion 7a of the second electrode 7 on the plane where the first gate electrode 1 is located are alternately placed. The shapes of the third electrode 6 and the fourth electrode 8 are both comb-shaped. The orthographic projection of the comb tooth portion of the third electrode 6 and the orthographic projection of the comb tooth portion 7a of the fourth electrode 8 on the plane where the second gate electrode 2 is located are alternately placed.

[0056] Fig. 3 is a top view of the first electrode and the second electrode in one embodiment of the present disclosure. As shown in FIG. 3, by designing the first electrode 5 and the second electrode 7 to be comb-like, and the comb-tooth portions 5a, 7a of the two electrodes are alternately arranged. As such, the width of the channel region can be effectively increased. In the case where the length of the channel region is constant and the width of the channel region is increased, the aspect ratio of the channel region is also increased. Accordingly, corresponding to the same gate-source voltage, the channel current in the channel region (ie, driving current) increases. At this time, the brightness of the first organic luminescent field effect transistor OLET_1 is increased.

[0057] It can be seen from the above that by designing the first electrode 5, the second electrode 7, the third electrode 6, and the fourth electrode 8 into a comb shape, the channel current in the organic luminescent field effect transistor can be effectively increased, and the display brightness can be improved.

[0058] In some embodiments, the first electrode 5 and the second electrode 7 are coupled to the surface of the first active luminescent layer 3 opposite from the substrate by a through hole respectively on the interlayer insulating layer 10. The third electrode 6 and the fourth electrode 8 are coupled to the surface of the second active luminescent layer 4 opposite from the substrate by a through hole respectively on the interlayer insulating layer 10. In one embodiment, the interlayer insulating layer 10 is made of a transparent insulating material. Of course, in the present disclosure, there are many different ways that the first/second/third/fourth electrodes are connected to the corresponding active luminescent layer. In some embodiments, the first electrode 5 and the second electrode 7 may also directly connect to the first active luminescent

layer 3. The third electrode 6 and the fourth electrode 8 can also be directly connected to the surface of the second active luminescent layer 4 opposite from the substrate.

[0059] Fig. 4 is a schematic cross-sectional view of an organic luminescent substrate according to one embodiment of the present disclosure. As shown in FIG. 4, unlike the above-described organic luminescent substrate shown in FIG. 1, the orthographic projections of the second electrode 7 and the fourth electrode 8 on the plane of the first active luminescent layer 3 (or second active luminescent layer 4) in the organic luminescent substrate shown in FIG. 4 do not overlap the first active luminescent layer 3 and the second active luminescent layer 4. The second electrode 7 and the fourth electrode 8 are connected to the corresponding first active luminescent layer 3 and the second active luminescent layer 4 respectively through the transparent electrode 11. As such, the second electrode 7 and the fourth electrode 8 do not block the first active luminescent layer 3, which can effectively reduce the light transmission loss.

[0060] FIG. 5 is a schematic cross-sectional view of an organic luminescent substrate according to one embodiment of the present disclosure. As shown in FIG. 5, unlike the organic luminescent substrate shown in FIG. 1 and FIG. 4, the first active luminescent layer 3 in the organic luminescent substrate shown in FIG. 5 includes an independent first active layer 3a and an independent first luminescent layer 3b. The second active luminescent layer 4 includes: an independent second active layer 4a and an independent second luminescent layer 4b. The first active layer 3a is located on a side of the first luminescent layer 3b facing the base substrate, and the second active layer 4a is located on a side of the second luminescent layer 4b facing the base substrate. The formation regions of the first luminescent layer 3b and the second luminescent layer 4b are defined by the pixel defining layer 12.

[0061] In some embodiments, the orthographic projection of the first luminescent layer 3b on the plane where the first active layer 3a is located covers a portion of the first active layer 3a. The first electrode 5 is coupled to a region of the first active layer 3a opposite from the base substrate and not covered by the first luminescent layer 3b, and the orthographic projection of the first electrode 5 on the plane where the first luminescent layer 3b is located does not overlap the

1 first luminescent layer 3b. That is, the first electrode 5 does not overlap the first luminescent
2 layer 3b, as shown in Fig. 5.

3 **[0062]** The orthographic projection of the second luminescent layer 4b on the plane
4 where the second active layer 4a is located covers a partial region of the second active layer 4a.
5 The third electrode 6 is connected to a region of the second active layer 4a opposite from the
6 substrate and not covered by the second luminescent layer 4b, and the orthographic projection of
7 the third electrode 6 on the plane where the second luminescent layer 4b is located does not
8 overlap the second luminescent layer 4b. That is, the third electrode 6 does not overlap the
9 second luminescent layer 3b, as shown in Fig. 5.

10 **[0063]** That is, in the organic luminescent substrate shown in FIG. 5, neither the first
11 electrode 5 nor the third electrode 6 obstructs the corresponding organic luminescent layer, and
12 the light transmission loss can be effectively reduced.

13 **[0064]** In some embodiments, in the organic luminescent substrate shown in FIG. 5, the
14 orthographic projections of the second electrode 7 and the fourth electrode 8 on the plane where
15 the first luminescent layer 3b (the second luminescent layer 4b) is located do not overlap the first
16 luminescent layer 3b and the second luminescent layer 4b. The second electrode 7 and the fourth
17 electrode 8 are electrically connected to the corresponding first and second luminescent layers 3b
18 and 4b through the transparent electrode 11. As such, since the first electrode 5, the second
19 electrode 7, the third electrode 6, and the fourth electrode 8 do not block the corresponding
20 organic luminescent layer, the light transmission loss can be further reduced.

21 **[0065]** In some embodiments, that the first active luminescent layer 3 shown in FIG. 5
22 comprising an independent first active layer 3a and an independent first luminescent layer 3b,
23 and the second active luminescent layer 4 comprising an independent second active layer 4a and
24 an independent second luminescent layer 4b is also applicable to the organic luminescent
25 substrate shown in FIGS. 1 and 4.

26 **[0066]** The specific structure of the first active luminescent layer 3 and the second active
27 luminescent layer 4, the relative positional relationship between the first electrode 5, the second

electrode 7 and the first active luminescent layer 3, the relative positional relationship between the third electrode 6, the fourth electrode 8 and the second active luminescent layer 4 are not limited. In the present disclosure, the first electrode 5 and the second electrode 7 are both electrically coupled to the first active luminescent layer 3, and the third electrode 6 and the fourth electrode 8 are both electrically coupled to the second active luminescent layer 4.

[0067] It should be noted that, in the organic luminescent substrate shown in FIG. 1, FIG. 4 and FIG. 5, the case where the first electrode 5 and the third electrode 6 are not coupled only serves as a schematic illustration, which does not limit the scope of the embodiments of the present disclosure. In the embodiments of the present disclosure, the first electrode 5 and the third electrode 6 may be selected to be connected or not connected according to actual needs, and all of them belong to the protection scope of the present disclosure.

[0068] Wherein, when the first electrode 5 and the third electrode 6 are not connected, different voltages may be input to the first electrode 5 and the third electrode 6 respectively to control the magnitudes of the drive currents of the first organic luminescent field effect transistor OLET_1 and the second organic luminescent field effect transistor OLET_2. However, at this time, two signal traces are required for the first electrode 5 and the third electrode 6.

[0069] When the first electrode 5 and the third electrode 6 are connected (the corresponding drawing is not given in this case), the first organic luminescent field effect transistor OLET_1 and the second organic luminescent field effect transistor OLET_2 are controlled only by the voltage inputted from the voltage input terminal. However, at this time, it is necessary to arrange only one signal trace for the first electrode 5 and the third electrode 6, which saves wiring space and is advantageous for high resolution of the display substrate.

[0070] Another example of the present disclosure provides a method for preparing an organic luminescent apparatus. FIG. 6 is a flow chart for a method for preparing an organic luminescent substrate shown in FIG. 1 and FIG. 4. FIGS. 7a to 7c are schematic diagrams showing the intermediate structures of the organic luminescent substrate prepared by the preparation method shown in FIG. 6. As shown in Fig. 6 to Fig. 7c, the method includes the following steps S101-S104.

1 **[0071]** Step S101 includes forming patterns of the first gate electrode and the second gate
2 electrode on the base substrate.

3 **[0072]** In one embodiment, as shown in Fig. 7a, a thin film of a metal conductive
4 material is formed on the base substrate, and then the thin film of the metal conductive material
5 is subjected to a patterning process to obtain a pattern of the first gate electrode 1 and the second
6 gate electrode 2. The first gate electrode 1 and the second gate electrode 2 are connected.

7 **[0073]** In the present disclosure, the thin film is usually formed by various methods such
8 as deposition, coating, sputtering, etc., and the specific method can be selected according to
9 actual needs. The patterning process specifically refers to a process including photoresist coating,
10 exposure, development, thin film etching, photoresist stripping, and the like.

11 **[0074]** Step S102 includes forming a gate electrode insulating layer on a side of the first
12 gate electrode and the second gate electrode opposite from the substrate.

13 **[0075]** As shown in FIG. 7b, a film of an insulating material is formed on the surface of
14 the base substrate prepared in step S101 to obtain a gate electrode insulating layer 9.

15 **[0076]** Step S103 includes forming patterns of the first active luminescent layer and the
16 second active luminescent layer on a side of the gate electrode insulating layer opposite from the
17 base substrate.

18 **[0077]** In some embodiments, as shown in FIG. 7c, the material of the first active
19 luminescent layer 3 includes a first organic luminescent semiconductor material, and the material
20 of the second active luminescent layer 4 includes a second organic luminescent semiconductor
21 material. One of the first organic luminescent semiconductor material and the second organic
22 luminescent semiconductor material is an N-type organic luminescent semiconductor material,
23 and the other is a P-type organic luminescent semiconductor material.

24 **[0078]** In some embodiments, step S103 specifically includes the following steps S1031
25 to S1035.

1 **[0079]** Step S1031 includes forming a pattern of the first active luminescent layer 3 on a
2 side of the gate electrode insulating layer opposite from the base substrate by one patterning
3 process.

4 **[0080]** In one embodiment, first, a first organic luminescent semiconductor material film
5 is formed on a side of the gate electrode insulating layer 9 opposite from the base substrate. Then,
6 the first organic luminescent semiconductor material film is patterned to obtain a pattern of the
7 first active luminescent layer.

8 **[0081]** Step S1032 includes forming a pattern of the second active luminescent layer on a
9 side of the gate electrode insulating layer opposite from the base substrate by one patterning
10 process.

11 **[0082]** In one embodiment, first, a second organic luminescent semiconductor material
12 film is formed on a side of the gate electrode insulating layer 9 opposite from the base substrate.
13 Then, the second organic luminescent semiconductor material film is patterned to obtain a
14 pattern of the second active luminescent layer 4.

15 **[0083]** In one embodiment, the first active luminescent layer 3 includes: a first active
16 layer and a first luminescent layer on a side of the first active layer opposite from the base
17 substrate. The second active luminescent layer 4 includes: a second active layer and a second
18 luminescent layer on a side of the second active layer opposite from the base substrate. The first
19 active layer and the second active layer are disposed in the same layer, and the first luminescent
20 layer and the second luminescent layer are disposed in the same layer (the corresponding
21 drawings are not given in this case).

22 **[0084]** In one embodiment, step S103 specifically includes:

23 **[0085]** Step S1033 includes forming patterns of the first active layer and the second
24 active layer on a side of the gate electrode insulating layer opposite from the base substrate by
25 one patterning process.

26 **[0086]** In one embodiment, first, a thin film of active material is formed on the surface of
27 the gate electrode insulating layer, such as a film of polysilicon material. In one embodiment,

1 first, an amorphous silicon (a-Si) film is formed on the surface of the gate electrode insulating
2 layer, and then the amorphous silicon film is processed by a laser annealing process to be
3 converted into a polysilicon (p-Si) film, thereby obtaining an active material film. Then, a
4 patterning process is performed on the active material film to obtain patterns of the first active
5 layer and the second active layer.

6 **[0087]** Step S1034 includes performing N-type doping on one of the first active layer and
7 the second active layer, and performing P-type doping on the other one of the first active layer
8 and the second active layer.

9 **[0088]** In this step, the first active layer and the second active layer are respectively
10 doped differently, one of which is P-doped and the other is N-doped to obtain a P-type
11 semiconductor and an N-type semiconductor, respectively.

12 **[0089]** Step S1035 involves forming a pattern of the first luminescent layer on a side of
13 the first active layer opposite from the base substrate, and forming a pattern of the second
14 luminescent layer on a side of the second active layer opposite from the base substrate. In one
15 embodiment, the first luminescent layer and the second luminescent layer are disposed in the
16 same layer.

17 **[0090]** In one embodiment, the first active luminescent layer 3 and the second active
18 luminescent layer 4 emit different colors of light when in a conductive state, thereby enhancing
19 the display gamut of the organic luminescent apparatus.

20 **[0091]** Step S104 includes forming patterns of the first electrode, the second electrode,
21 the third electrode, and the fourth electrode on a side of the first active luminescent layer and the
22 second active luminescent layer opposite from the base substrate.

23 **[0092]** In one embodiment, the second electrode 7 is directly coupled to the first active
24 luminescent layer 3 and the fourth electrode 8 is directly coupled to the second active
25 luminescent layer 4, as shown in FIG. 1. First, a film of an insulating material is formed on the
26 surface of the substrate prepared in step S104, and then a patterning process is performed on the
27 film of the insulating layer material to obtain a pattern of the interlayer insulating layer 10,

wherein the interlayer insulating layer 10 is formed with first and second through holes. Then, a thin film of a metal material is formed on the side of the interlayer insulating layer 10 opposite from the base substrate, and the metal material film is subjected to a patterning process to obtain patterns of the first electrode 5, the second electrode 7, and the third electrode 6, and the fourth electrode 8. The first electrode 5 and the second electrode 7 are both coupled to the first active luminescent layer 3, and the third electrode 6 and the fourth electrode 8 are both coupled to the second active luminescent layer 4.

[0093] In one embodiment, as shown in FIG. 4, the orthographic projection of the second electrode 7 and the fourth electrode 8 on the plane where the first active luminescent layer 3 (the second active luminescent layer 4) is located does not overlap the first active luminescent layer 3 and the second active luminescent layer 4. The second electrode 7 and the fourth electrode 8 are coupled to the corresponding first active luminescent layer 3 and the second active luminescent layer 4 through the transparent electrode 11. In this step, after patterning the first electrode 5, the second electrode 7, the third electrode 6, and the fourth electrode 8 by an one-time patterning process, a transparent conductive film needs to be further formed, and then a patterning process is performed on the transparent conductive film to obtain a pattern of transparent electrode 11.

[0094] In one embodiment, the shape of the first electrode 5 and the second electrode 7 are both comb-shaped, and the orthographic projection of comb tooth portion of the first electrode 5 on the plane of the first gate electrode 1 and the orthographic projection of the comb tooth portion of the second electrode 7 on the plane of the first gate electrode 1 are alternately disposed. The shape of the third electrode 6 and the fourth electrode 8 are both comb-shaped, and the orthographic projection of comb tooth portion of the third electrode 6 on the plane of the second gate electrode 2 and the orthographic projection of the comb tooth portion of the fourth electrode 8 on the plane of the second gate electrode 2 are alternately disposed. By designing the first electrode 5, the second electrode 7, the third electrode 6, and the fourth electrode 8 to be comb-like, the channel current in the organic luminescent field effect transistor can be effectively increased, and the display brightness can be improved.

1 **[0095]** It should be noted that, in this embodiment, the first electrode 5 and the third
2 electrode 6 may be connected or not connected according to actual needs.

3 **[0096]** Fig. 8 is a flow chart of a method for preparing an organic luminescent substrate
4 shown in FIG. 5, and FIGS. 9a to 9f are schematic diagrams showing intermediate structures of
5 the organic luminescent substrate prepared by the preparation method shown in FIG. 8. As
6 shown in FIGS 8 to 9f, the preparation method includes the following:

7 **[0097]** Step S201 includes forming patterns of the first gate electrode and the second gate
8 electrode on the base substrate.

9 **[0098]** Step S202 includes forming a gate electrode insulating layer on a side of the first
10 gate electrode and the second gate electrode opposite from the base substrate.

11 **[0099]** For the detailed description of step S201 and step S202, the foregoing description
12 of step S101 and step S102 can be consulted, and details are not described herein again.

13 **[00100]** Step S203 includes forming patterns of the first active layer and the second active
14 layer on a side of the gate electrode insulating layer opposite from the base substrate.

15 **[00101]** In one embodiment, as shown in Fig. 9a, first, a thin film of active material, such
16 as a film of polysilicon material, is formed on the surface of the gate electrode insulating layer 9.
17 Specifically, an amorphous silicon (a-Si) film is formed on the surface of the gate electrode
18 insulating layer 9, and then the amorphous silicon film is processed by a laser annealing process
19 to be converted into a polysilicon (p-Si) film, thereby obtaining an active material film. Next, a
20 patterning process is performed on the active material film to obtain patterns of the first active
21 layer 3a and the second active layer 4a.

22 **[00102]** Step S204 includes performing P-type doping on one of the first active layer and
23 the second active layer, and performing N-type doping on the other one of the first active layer
24 and the second active layer.

1 **[00103]** As shown in FIG. 9b, the first active layer 3a and the second active layer 4a are
2 respectively doped differently, one of which is P-doped and the other is N-doped to obtain a P-
3 type semiconductor and an N-type semiconductor respectively.

4 **[00104]** Step S205 includes forming an interlayer insulating layer on a side of the first
5 active layer and the second active layer opposite from the base substrate. As shown in FIG. 9c, a
6 film of an insulating material is formed on the surface of the substrate prepared in step S204, and
7 then a patterning process is performed on the film of the insulating layer material to obtain a
8 pattern of the interlayer insulating layer 10. The interlayer insulating layer 10 is formed with first
9 and second through holes corresponding to regions where the first electrode 5 and the third
10 electrode 6 are to be formed later.

11 **[00105]** Step S206 includes forming a first electrode, a second electrode, a third electrode,
12 and a fourth electrode on a side of the interlayer insulating layer opposite from the base substrate.

13 **[00106]** As shown in FIG. 9d, a thin film of a metal material is formed on a side of the
14 interlayer insulating layer 10 opposite from the substrate, and a patterning process is performed
15 on the film of the metal material to obtain patterns of a first electrode 5, a second electrode 7, a
16 third electrode 6 and a fourth electrode 8.

17 **[00107]** The first electrode 5 and the third electrode 6 are respectively coupled to the
18 corresponding first active layer 3a and the second active layer 4a through a first and a second
19 through hole. The orthographic projection of the second electrode 7 and the fourth electrode 8 on
20 the plane where the first luminescent layer 3b (or the second luminescent layers 4b) are located
21 does not overlap the first luminescent layer 3b and the second luminescent layer 4b subsequently
22 formed.

23 **[00108]** Step S207 includes forming a pixel defining layer on a side of the interlayer
24 insulating layer opposite from the substrate.

25 **[00109]** As shown in FIG. 9e, a film of a pixel defining material is formed on a side of the
26 interlayer insulating layer 10 opposite from the substrate, and the film of the pixel defining
27 material is patterned by a patterning process to obtain a pattern of the pixel defining layer 12.

1 Third and fourth through holes are formed on the pixel defining layer 12 at positions
2 corresponding to the first luminescent layer 3b and the second luminescent layer 4b, and the third
3 and fourth through holes are penetrated to the side of the first active layer 3a and the second
4 active layer 4a opposite from the base substrate through the over-etching process. Through holes
5 are also provided on the regions of the pixel defining layer 12 corresponding to the second
6 electrode 7 and the fourth electrode 8.

7 **[00110]** Step 208 includes forming a first luminescent layer and a second luminescent
8 layer respectively in the third and fourth through holes of the pixel defining layer corresponding
9 to the first active layer and the second active layer respectively.

10 **[00111]** As shown in FIG. 9f, a process of forming a luminescent layer by inkjet printing
11 is taken as an example, and a first luminescent material solution is sprayed into the third through
12 hole in the pixel defining layer 12 corresponding to the first active layer 3a, and then the first
13 luminescent material solution is subjected to a drying treatment to obtain a first luminescent
14 layer 3b. A second luminescent material solution is sprayed into the fourth through hole in the
15 pixel defining layer 12 corresponding to the second active layer 4a, and then the second
16 luminescent material solution is subjected to a drying treatment to obtain a second luminescent
17 layer 4b.

18 **[00112]** Of course, the first luminescent layer 3b and the second luminescent layer 4b may
19 also be formed by evaporation deposition, and the specific process is not described in detail
20 herein.

21 **[00113]** Step S209 includes forming a transparent electrode on a side of the pixel defining
22 layer opposite from the substrate.

23 **[00114]** Referring to FIG. 5, a transparent conductive film is formed on a side of the pixel
24 defining layer 12 opposite from the substrate, and a patterning process is performed on the
25 transparent conductive film to obtain a pattern of the transparent electrode 11. The transparent
26 electrode 11 is coupled to the second electrode 7 and the fourth electrode 8 by through holes and
27 is coupled to the first luminescent layer 3b and the second luminescent layer 4b.

1 **[00115]** Fig. 10 is a schematic structural diagram of a circuit of a display apparatus
2 according to one embodiment of the present disclosure, and FIG. 11 is a schematic structural
3 diagram of a circuit in a display area of FIG. 10. As shown in FIG. 10 and FIG. 11, the display
4 apparatus includes an organic luminescent substrate. The organic luminescent substrate is the
5 organic luminescent substrate provided according to one embodiment of the present disclosure.
6 The detailed description of the organic luminescent substrate can be consulted with the content in
7 the first embodiment, and the details thereof are not repeated herein.

8 **[00116]** In some embodiments, the display apparatus further includes: a plurality of gate
9 lines GATE_1 / GATE_2 ... and a plurality of data lines DATA_1 / DATA_2 The gate lines
10 GATE_1/GATE_2... and the data lines DATA_1/DATA_2... are arranged to define a plurality of
11 display areas in an array, and the organic luminescent apparatuses and the display areas are in
12 one-to-one correspondence. The display area includes: a first sub-pixel area P_1 and a second
13 sub-pixel area P_2, the first organic luminescent field effect transistor OLET_1 is located in the
14 corresponding first sub-pixel area P_1, and the second organic luminescent field effect transistor
15 OLET_2 is located in the corresponding second sub-pixel area P_2. In this embodiment, the first
16 organic luminescent field effect transistor OLET_1 and the second organic luminescent field
17 effect transistor OLET_2 in the adjacent columns can use the same data line to provide the data
18 voltage. As such, the number of wires of the data lines in the display substrate can be reduced,
19 which is advantageous for high resolution of the display substrate.

20 **[00117]** The display apparatus further includes a plurality of switching transistors TFT.
21 The switching transistor TFTs are in one-to-one correspondence with the organic luminescent
22 apparatuses. The gate electrode of the switching transistor TFT is connected to the corresponding
23 gate line, the source of the switching transistor TFT is connected to the corresponding data line,
24 and the drain of the switching transistor TFT is connected to the first gate electrode 1 and the
25 second gate electrode 2 of the corresponding organic luminescent apparatuses.

26 **[00118]** In one embodiment, the operation of the display apparatus shown in FIG. 10 will
27 be described in detail below with reference to the accompanying drawings. In the embodiment,
28 the switching transistor TFT is an N-type transistor, the first organic luminescent field effect

transistor OLET_1 is an N-type transistor, and the second organic luminescent field effect transistor OLET_2 is a P-type transistor. In the present disclosure, the high-level data voltage (referred to as V+) refers to a data voltage capable of turning on the N-type transistor and turning off the P-type transistor in the organic luminescent apparatus. The low-level data voltage (referred to as V-) specifically refers to a data voltage capable of turning on the P-type transistor and turning off the N-type transistor in the organic luminescent apparatus.

[00119] In this embodiment, the first electrode 5 is connected to the first working voltage Vss, the second electrode 7 (the fourth electrode 8) is connected to the second working voltage Vdd, and the third electrode is connected to the third working voltage Vss', wherein $V_{ss} > V_{dd} > V_{ss'}$. The first electrode 5 and the third electrode 6 are both sources, and the second electrode 7 and the fourth electrode 8 are both drains. Correspondingly, the high level data voltage refers to a voltage whose voltage value is greater than $V_{dd} + V_{th_N}$, and the low level data voltage refers to a data voltage whose voltage value is less than $V_{dd} + V_{th_P}$, wherein V_{th_N} is the threshold voltage of the first organic luminescent field effect transistor OLET_1, and V_{th_P} is the threshold voltage of the second organic luminescent field effect transistor OLET_2.

[00120] Fig. 12a is a schematic diagram of a driving sequence of the display apparatus shown in FIG. 10. As shown in FIG. 12a, as an optional time-division driving scheme, scan signals are input to each gate electrode line one by one according to a first scan period. Each first scan period is divided into a first half period and a second half period. In the first half period, the data line provides a high-level data voltage, and in the second half of the cycle, the data line provides a low-level data voltage.

[00121] Wherein, in the case that the first scan period (scanning time per line) is equal to the clock signal period, the durations of the first half period and the second half period can be controlled by the duration of the high and low periods in the clock signal period.

[00122] Taking the first row gate line GATE_1 as an example, when a high level signal is input in the first row gate line GATE_1, the switching transistors TFTs in the display regions of the first row are turned on. In the first half period, a high-level data voltage is supplied in each of

the data lines DATA_1/DATA_2, . . . so that the first organic luminescent field effect transistor OLET_1 in each of the first sub-pixel regions P_1 of the first row emits light. By controlling the magnitude of the high-level data voltage in each of the data lines DATA_1/DATA_2, the illumination brightness of each of the first organic luminescent field effect transistors OLET_1 located in the first row can be controlled. In the second half period, a low-level data voltage is supplied in each of the data lines DATA_1/DATA_2, . . . so that the second organic luminescent field effect transistor OLET_2 in each of the second sub-pixel regions P_2 of the first row emits light. By controlling the magnitude of the low-level data voltage in each data line DATA_1/DATA_2, the illumination brightness of each of the second organic luminescent field effect transistors OLET_2 located in the first row can be controlled.

[00123] Under the effect of vision persistence, the user will perceive that the first organic luminescent field effect transistors OLET_1 and the second organic luminescent field effect transistors OLET_2 in the first row simultaneously emit light.

[00124] Based on the same principle described above, the user will perceive a complete picture after the gate lines are scanned line by line.

[00125] Fig. 12b is another schematic diagram of driving timing of the display apparatus shown in FIG. 10. As shown in FIG. 12b, as another optional time division driving scheme, each complete picture includes: a previous frame and a subsequent frame. When the previous frame is displayed, a scanning signal is input to the respective gate line one by one according to a second scanning period, wherein the data line provides a high level data voltage in each of the second scan periods. When the subsequent frame is displayed, a scan signal is input to the respective gate line one by one according to the second scan period, wherein the data line provides the low level data voltage in each of the second scan periods.

[00126] In the driving scheme shown in Fig. 12b, the second scan period (scan time per line) is equal to half a clock period.

[00127] When the previous frame is displayed, the scan signals are input to the gate lines GATE_1/GATE_2... one by one, and each of the data lines DATA_1/DATA_2... provides a

1 high-level data voltage, the first organic luminescent field effect transistors OLET_1 in the
2 display substrate emits light line by line. By controlling the magnitude of the high-level data
3 voltage in each of the data lines DATA_1/DATA_2, the luminescent brightness of each of the
4 first organic luminescent field effect transistors OLET_1 can be controlled. The illumination of
5 all the first organic luminescent field effect transistors OLET_1 constitutes the previous frame
6 picture.

7 **[00128]** When the subsequent frame is displayed, the scan signals are input to the gate
8 lines GATE_1/GATE_2, and each of the data lines DATA_1/DATA_2 provides the low-level
9 data voltage. The second organic luminescent field effect transistors OLET_2 in the display
10 substrate emit line by line. By controlling the magnitude of the low-level data voltage in each of
11 the data lines DATA_1/DATA_2, the illumination brightness of each of the second organic
12 luminescent field effect transistors OLET_2 can be controlled. The illumination of all the second
13 organic luminescent field effect transistors OLET_2 constitutes the next frame picture.

14 **[00129]** Although the previous frame and the subsequent frame are alternately displayed,
15 the user will perceive a complete picture due to the visual persistence.

16 **[00130]** It can be seen that the technical solution of the present disclosure can realize the
17 control of the luminance of the organic luminescent field effect transistors in the adjacent two
18 columns of sub-pixel regions by using one column of data line. As such, the number of data lines
19 in the display substrate can be halved, and the number of sub-pixel regions that can be disposed
20 in the display substrate is increased, which is advantageous for high-resolution products.

21 **[00131]** It should be noted that, in the embodiments, that the first organic luminescent
22 field effect transistor OLET_1 is an N-type transistor and the second organic luminescent field
23 effect transistor OLET_2 is a P-type transistor only serves as an example. In some embodiments
24 of the present disclosure, the first organic luminescent field effect transistor OLET_1 is a P-type
25 transistor and the second organic luminescent field effect transistor OLET_2 is an N-type
26 transistor, and the details are not described again herein.

1 **[00132]** In some embodiments, two organic luminescent field effect transistors in each of
2 the organic luminescent apparatuses connected to the data lines of the odd-numbered columns
3 emit green light and red light, respectively. Two organic luminescent field effect transistors in
4 each of the organic luminescent apparatuses connected to the data lines of the even-numbered
5 columns emit green light and blue light, respectively. As such, the display substrate can display a
6 color picture.

7 **[00133]** Another example of the present disclosure provides a display driving method for a
8 display apparatus, wherein the display apparatus adopts a display substrate according to one
9 embodiment of the present disclosure. The driving method of the display apparatus includes
10 inputting a scan signal to each gate line one by one according to a first scan period. Each of the
11 first scanning periods is divided into a first half period and a second half period. In the first half
12 period, the data line provides a first type of data voltage, and in the second half period, the data
13 line provides a second type of data voltage. One of the first type of data voltage and the second
14 type of data voltage is a high level data voltage, and the other is a low level data voltage.

15 **[00134]** Another example of the present disclosure provides a display driving method for a
16 display apparatus, wherein the display apparatus adopts the display substrate according to one
17 embodiment of the present disclosure. Each complete picture displayed by the display substrate
18 includes: a previous frame and a subsequent frame. In one embodiment, the driving method of
19 the display substrate includes the following:

20 **[00135]** When the previous frame is displayed, the scan signals are input to the respective
21 gate lines one by one according to the second scan period, wherein the data lines provide the first
22 type of data voltages in each of the second scan periods.

23 **[00136]** When the subsequent frame is displayed, the scan signals are input to the
24 respective gate lines one by one according to the second scan period, wherein the data lines all
25 provide the second type of data voltage in each of the second scan periods. One of the first type
26 of data voltage and the second type of data voltage is a high level data voltage, and the other is a
27 low level data voltage.

1 **[00137]** The principle and the embodiment of the present disclosures are set forth in the
2 specification. The description of the embodiments of the present disclosure is only used to help
3 understand the method of the present disclosure and the core idea thereof. Meanwhile, for a
4 person of ordinary skill in the art, the disclosure relates to the scope of the disclosure, and the
5 technical scheme is not limited to the specific combination of the technical features, and also
6 should covered other technical schemes which are formed by combining the technical features or
7 the equivalent features of the technical features without departing from the inventive concept.
8 For example, technical scheme may be obtained by replacing the features described above as
9 disclosed in this disclosure (but not limited to) with similar features.

CLAIMS

What is claimed is:

1. An organic luminescent substrate, comprising:

a first organic luminescent field effect transistor, comprising a first gate electrode, a first electrode, a second electrode, and a first active luminescent layer

and a second organic luminescent field effect transistor, comprising a second gate electrode, a third electrode, a fourth electrode, and a second active luminescent layer;

wherein one of the first organic luminescent field effect transistor and the second organic luminescent field effect transistor is an N-type transistor and the other one is a P-type transistor; and

the first gate electrode is coupled to the second gate electrode.

2. The organic luminescent substrate of claim 1, wherein the second electrode is coupled to the fourth electrode, the first electrode and the second electrode are both coupled to the first active luminescent layer, and the third electrode and the fourth electrode are both coupled to the second active luminescent layer.

3. The organic luminescent substrate of claim 1, wherein the first active luminescent layer comprises a first organic luminescent semiconductor material; the second active luminescent layer comprises a second organic luminescent semiconductor material; one of the first organic luminescent semiconductor material and the second organic luminescent semiconductor material is an N type organic luminescent semiconductor material, and the other one is a P type organic luminescent semiconductor material.

1 4. The organic luminescent substrate of claim 1, wherein the first active
2 luminescent layer comprises a first active layer and a first luminescent layer on a side of
3 the first active layer;

4 the second active luminescent layer comprises a second active layer and a second
5 luminescent layer on a side of the second active layer; and

6 the first active layer and the second active layer are in a same layer, and the first
7 luminescent layer and the second luminescent layer are in a same layer.

8 5. The organic luminescent substrate of claim 4, wherein an orthographic
9 projection of the first luminescent layer on a plane where the first active layer is located
10 covers a partial region of the first active layer, the first electrode is coupled to a region on
11 a side of the first active layer opposite from the base substrate and not covered by the first
12 luminescent layer, and an orthographic projection of the first electrode on the plane
13 where the first active layer is located does not overlap an orthographic projection of the
14 first luminescent layer on the plane where the first active layer is located; and

15 an orthographic projection of the second luminescent layer on a plane where the
16 second active layer is covers a partial region of the second active layer, the third electrode
17 is coupled to a region on a side of the second active layer opposite from the base
18 substrate and not covered by the second luminescent layer, and an orthographic
19 projection of the third electrode on the plane where the second active layer is does not
20 overlap the orthographic projection of second luminescent layer on the plane where the
21 second active layer is.

22 6. The organic luminescent substrate of claim 1, wherein an orthographic
23 projection of the second electrode on a plane where the first active luminescent layer is
24 located does not overlap the first active luminescent layer; and

25 an orthographic projection of the fourth electrode on a plane where the second
26 active luminescent layer is does not overlap the second active luminescent layer.

1 7. The organic luminescent substrate of claim 6, further comprising a transparent
2 electrode,

3 wherein the transparent electrode couples the first active luminescent layer with the
4 second electrode, and couples the second active luminescent layer with the fourth
5 electrode.

6 8. The organic luminescent substrate of claim 1, wherein the first active
7 luminescent layer and the second active luminescent layer are configured to emit light of
8 different colors in a conductive state.

9 9. The organic luminescent substrate of claim 1, wherein the first electrode and the
10 second electrode each have a comb shape comprising a comb tooth portion, an
11 orthographic projection of the comb tooth portion of the first electrode on a plane where
12 the first gate electrode is and an orthographic projection of the comb tooth portion of the
13 second electrode on the plane where the first gate electrode is are alternately disposed;

14 wherein the third electrode and the fourth electrode each have a comb shape
15 comprising a comb tooth portion, an orthographic projection of the comb tooth portion of
16 the third electrode on a plane where the second gate electrode is and an orthographic
17 projection of the comb tooth portion of the fourth electrode on the plane where the
18 second gate electrode is are alternately disposed.

19 10. The organic luminescent substrate of any one of claims 1-9, wherein the first
20 electrode is electrically coupled to the third electrode.

21 11. A method of preparing an organic luminescent substrate, comprising:

22 forming patterns of a first gate electrode and a second gate electrode on a base
23 substrate, the first gate electrode and the second gate electrode being electrically coupled;

24 forming a gate electrode insulating layer on a side of the first gate electrode and the
25 second gate electrode opposite from the base substrate;

1 forming patterns of the first active luminescent layer and the second active
2 luminescent layer on a side of the gate electrode insulating layer opposite from the base
3 substrate; and

4 forming patterns of a first electrode, a second electrode, a third electrode, and a
5 four-electrode on a side of the first active luminescent layer and the second active
6 luminescent layer opposite from the base substrate.

7 12. The method of preparing an organic luminescent substrate of claim 11,
8 wherein forming the patterns of the first active luminescent layer and the second active
9 luminescent layer on the side of the gate electrode insulating layer opposite from the base
10 substrate comprises:

11 forming patterns of a first active layer and a second active layer on the side of the
12 gate electrode insulating layer opposite from the base substrate by one patterning process;

13 performing N-type doping on one of the first active layer and the second active
14 layer, and performing P-type doping on the other one thereof; and

15 forming a pattern of the first luminescent layer on a side of the first active layer
16 opposite from the base substrate and a pattern of the second luminescent layer on a side
17 of the second active layer opposite from the base substrate.

18 13. The method of preparing an organic luminescent substrate of claim 11,
19 wherein forming the patterns of the first active luminescent layer and the second active
20 luminescent layer on the side of the gate electrode insulating layer opposite from the base
21 substrate comprises:

22 forming patterns of a first active layer and a second active layer on a side of the
23 gate electrode insulating layer opposite from the base substrate;

24 performing N-type doping on one of the first active layer and the second active
25 layer, and performing P-type doping on the other one thereof;

1 forming an interlayer insulating layer on a side of the first active layer and the
2 second active layer opposite from the base substrate, and forming a first through hole and
3 a second through hole respectively in regions of the interlayer insulating layer
4 corresponding to the first electrode and the third electrode formed subsequently; and

5 forming a first electrode, a second electrode, a third electrode, and a fourth
6 electrode on a side of the interlayer insulating layer opposite from the base substrate;

7 wherein the first electrode is coupled to the first active layer through the first
8 through hole, the third electrode is coupled to the second active layer through the second
9 through hole; an orthographic projection of the second electrode and the fourth electrode
10 on a plane where the first active layer is does not overlap the orthographic projection of
11 first luminescent layer and the second luminescent layer formed subsequently on the
12 plane where the first active layer is, and the second electrode is electrically coupled to the
13 fourth electrode.

14 14. The method of preparing an organic luminescent substrate of claim 11,
15 wherein forming patterns of the first electrode, the second electrode, the third electrode,
16 and the a four-electrode on the side of the first active luminescent layer and the second
17 active luminescent layer opposite from the base substrate comprises forming a
18 transparent electrode, the transparent electrode coupling the first active luminescent layer
19 with the second electrode as well as coupling the second active luminescent layer with
20 the fourth electrode.

21 15. The method of preparing an organic luminescent substrate of claim 13, further
22 comprising forming a pixel defining layer on a side of the interlayer insulating layer
23 opposite from the base substrate;

24 wherein a region of the pixel defining layer on the first active layer and a region of
25 the pixel defining layer on the second active layer are provided with a third through hole
26 and a fourth through hole respectively.

1 16. The method of preparing an organic luminescent substrate of claim 15, further
2 comprising forming the first luminescent layer and the second luminescent layer
3 respectively in the third through hole and the fourth through hole; and

4 forming a transparent electrode on a side of the pixel defining layer opposite from
5 the base substrate, the transparent electrode coupling the first luminescent layer with the
6 second electrode as well as coupling the second luminescent layer with the fourth
7 electrode.

8 17. A display apparatus, comprising the organic luminescent substrate according
9 to any one of claims 1-10.

10 18. The display apparatus of claim 17, further comprising a plurality of gate lines
11 and a plurality of data lines, the plurality of the gate lines and the plurality of the data lines
12 defining a plurality of display areas arranged in an array, and the organic luminescent
13 substrate has a one-to-one correspondence with each of the plurality of the display areas,
14 each of the plurality of the display areas comprising a first sub-pixel region and a second
15 sub-pixel region, the first organic luminescent field effect transistor is located in the
16 corresponding first sub-pixel region, and the second organic luminescent field effect
17 transistor is located in the corresponding second sub-pixel region.

18 19. The display apparatus of claim 18, further comprising a switching transistor,

19 wherein the switching transistor has a one-to-one correspondence with the organic
20 luminescent apparatus, a gate electrode of the switching transistor is coupled to a
21 corresponding one of the plurality of the gate lines, a source of the switching transistor is
22 coupled to a corresponding one of the plurality of the data lines, and a drain of the
23 switching transistor is coupled to the first gate electrode and the second gate electrode of
24 the corresponding organic luminescent apparatus.

25 20. A display driving method of the display apparatus of claim 19, comprising:

1 inputting scanning signals to each of the gate lines one by one according to a first
2 scanning period,

3 wherein the first scanning period comprises a first half period and a second half
4 period, each of the data lines provides a first type of data voltage in the first half period
5 and a second type of data voltage in the second half period, one of the first type of data
6 voltage and the second type of data voltage is a high level data voltage, and the other one
7 is a low level data voltage.

8 21. A display driving method of the display apparatus of claim 19, each complete
9 picture comprising a previous frame and a subsequent frame, the display driving method
10 comprising:

11 inputting scan signals to each of the gate lines one by one according to a second
12 scan period during a time of displaying the previous frame, wherein the data lines each
13 provide a first type of data voltage in each second scan period;

14 inputting scan signals to each of the gate lines one by one according to the second
15 scan period during a time of displaying the subsequent frame, wherein the data lines each
16 provide a second type of data voltage in each second scan period; and

17 one of the first type of data voltage and the second type of data voltage is a high
18 level data voltage, and the other one thereof is a low level data voltage.

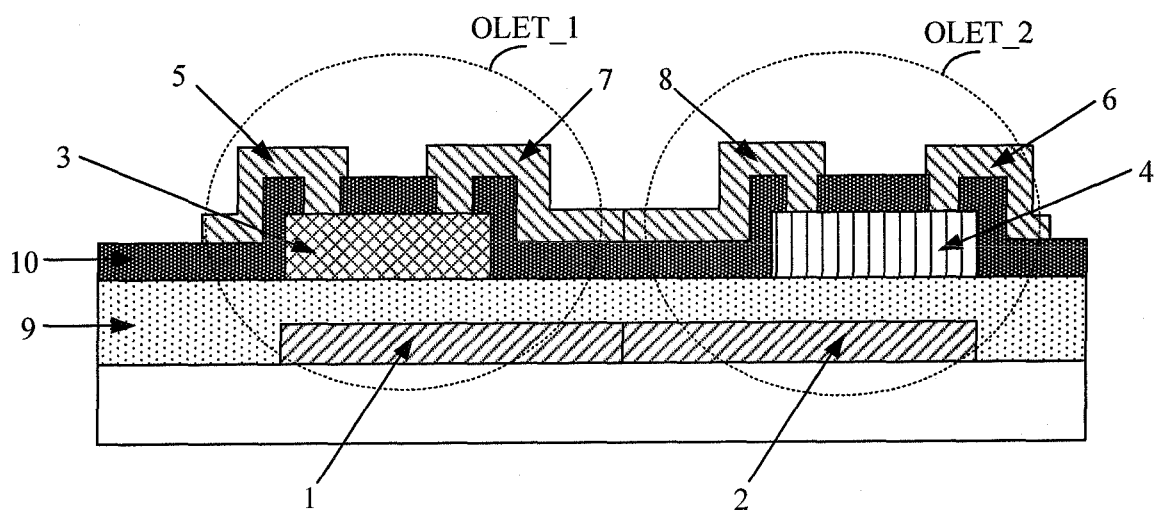


Fig. 1

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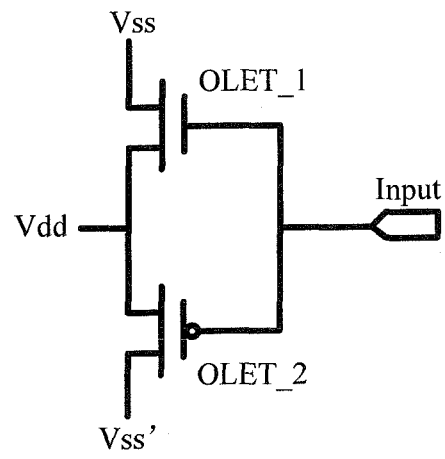


Fig. 2

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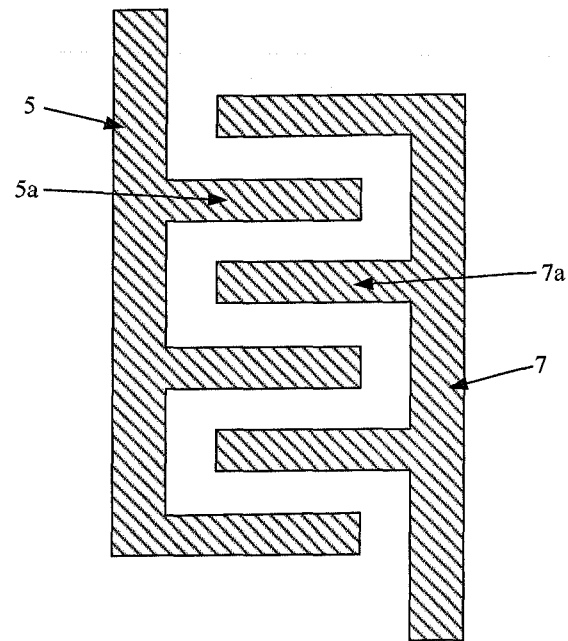


Fig. 3

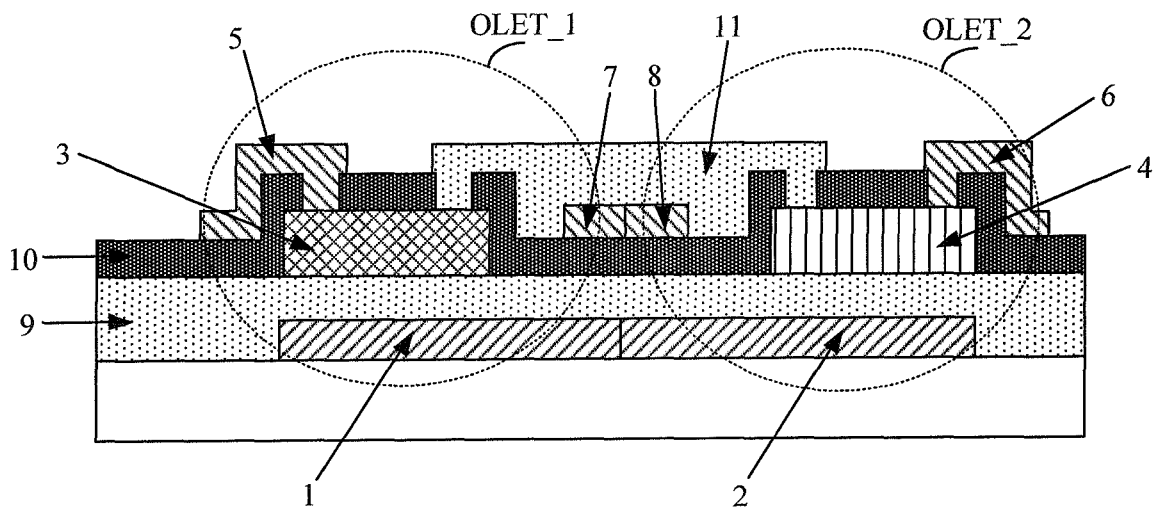


Fig. 4

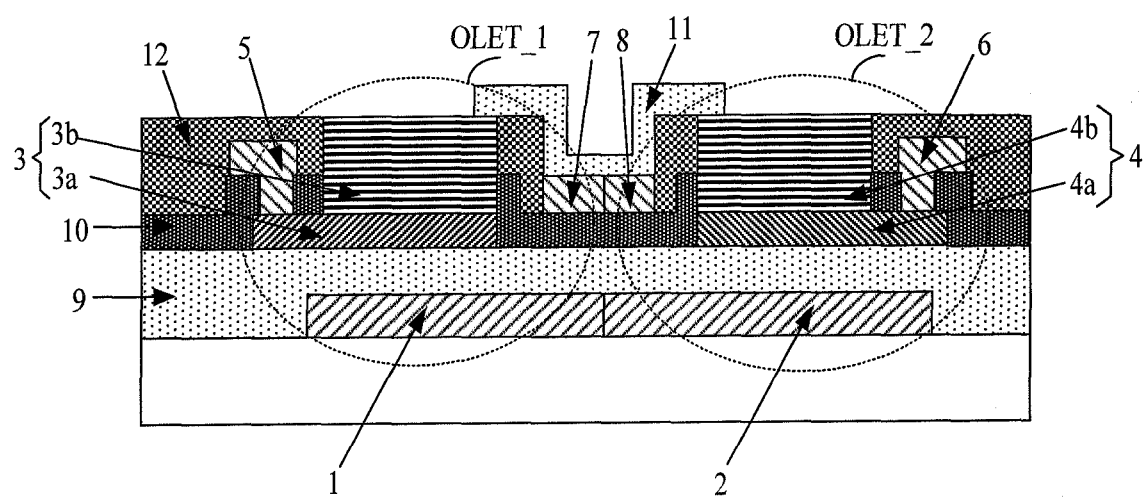


Fig. 5

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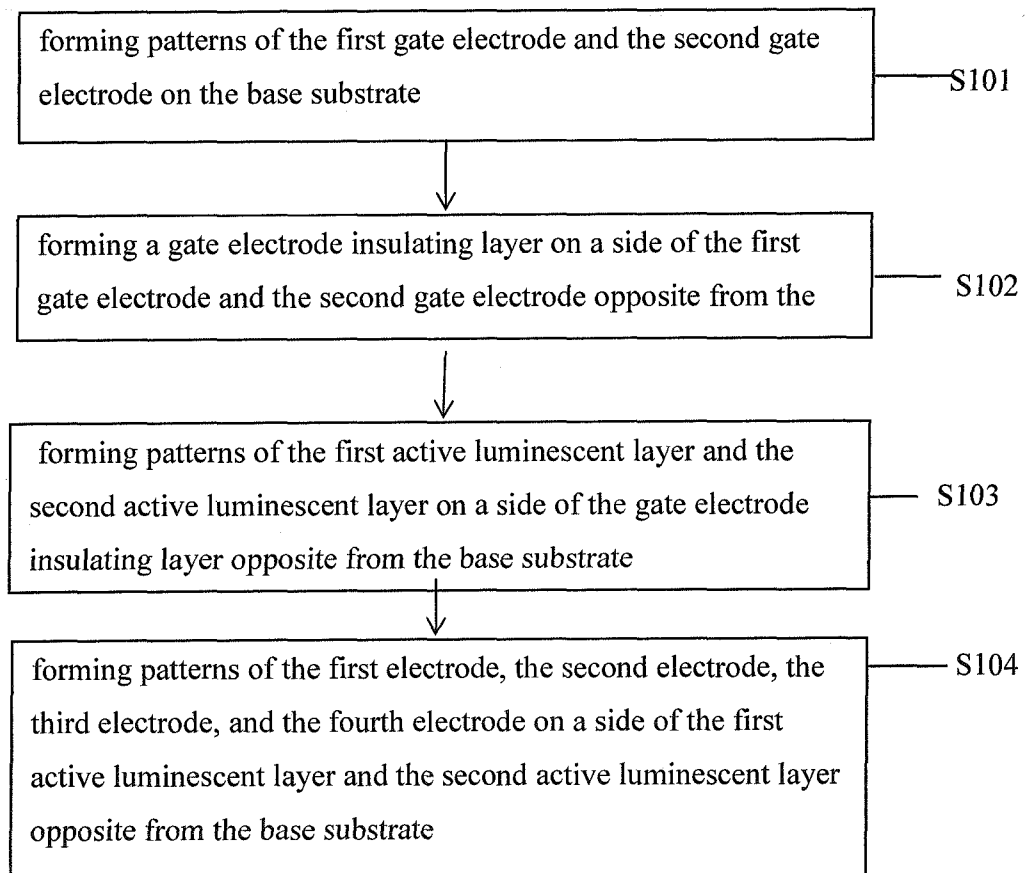


Fig. 6

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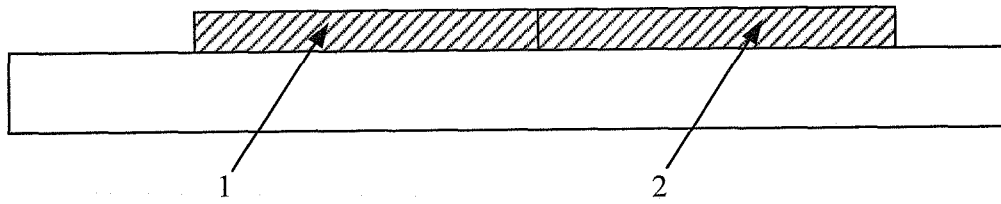


Fig. 7a

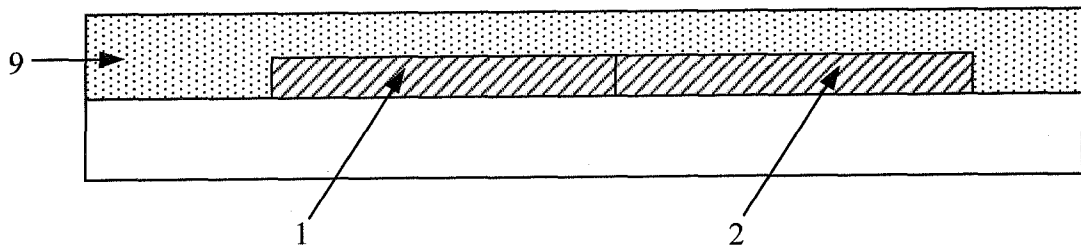


Fig. 7b

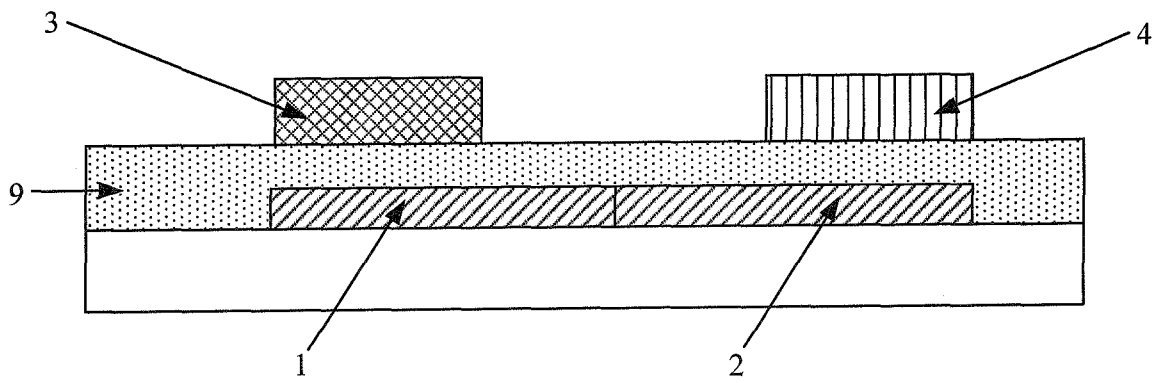


Fig. 7c

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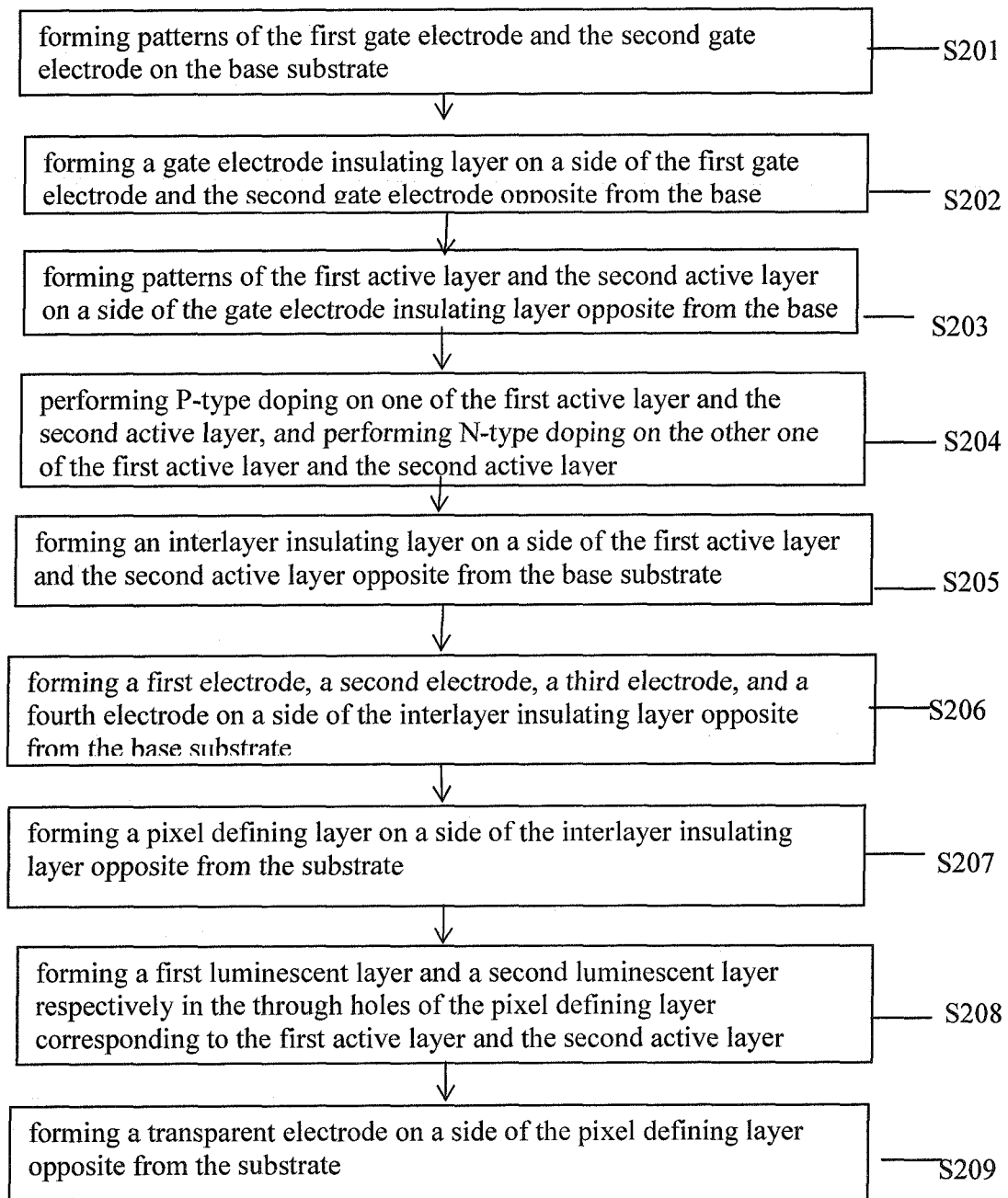


Fig. 8

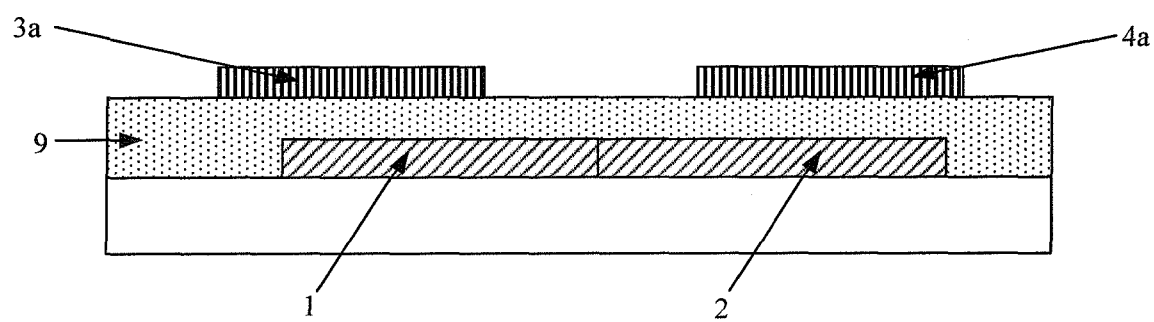


Fig. 9a

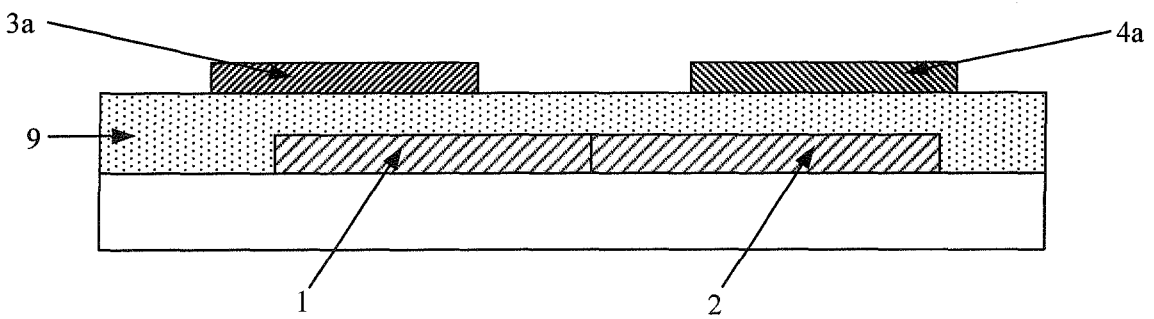


Fig. 9b

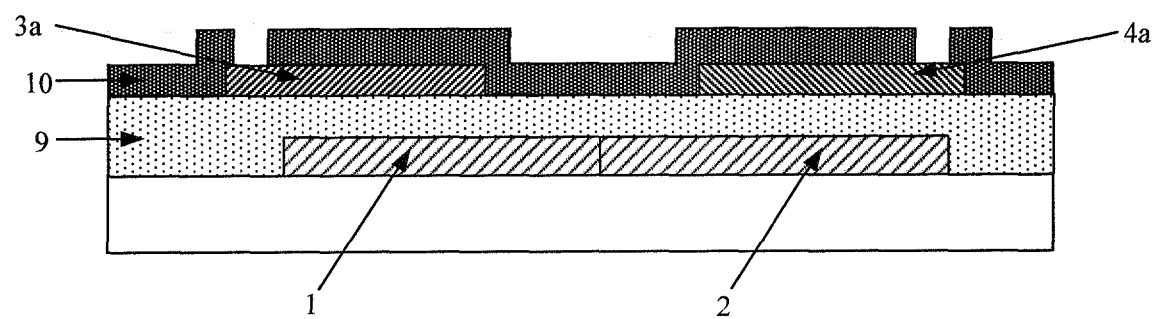


Fig. 9c

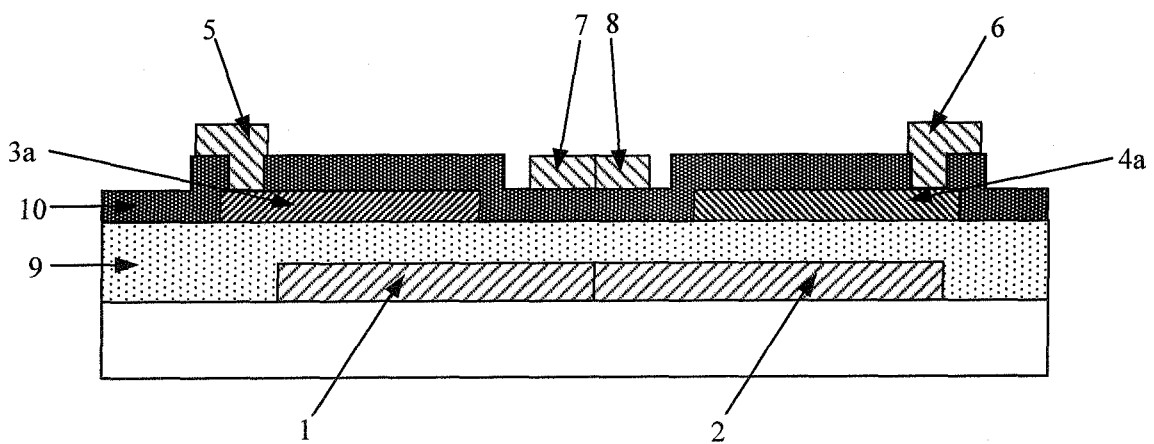


Fig. 9d

11/15

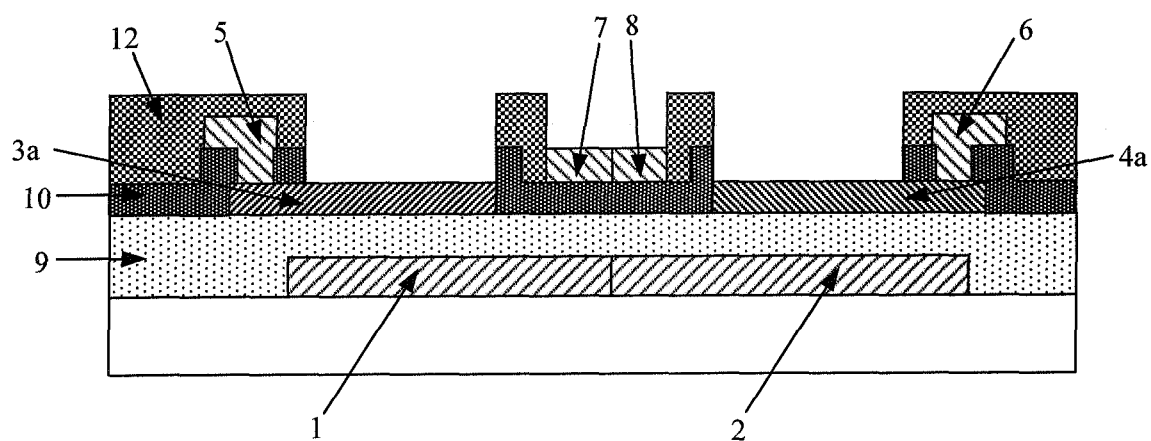


Fig. 9e

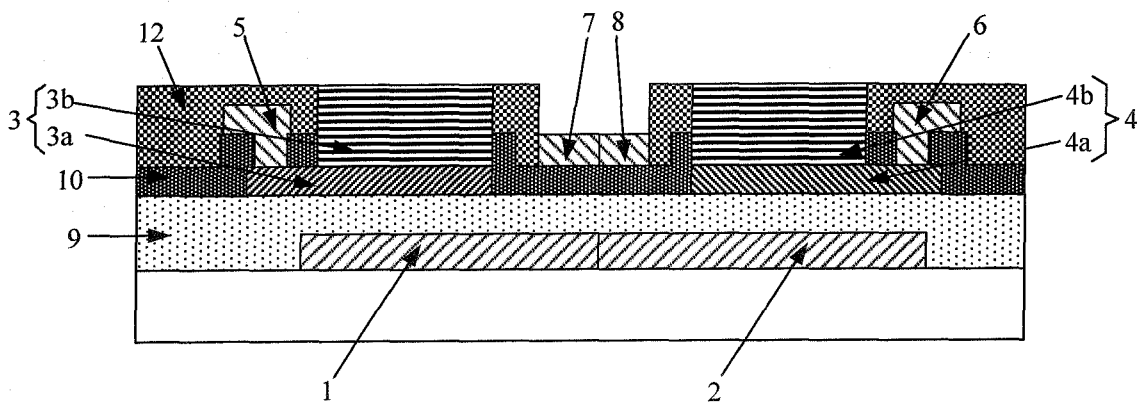


Fig. 9f

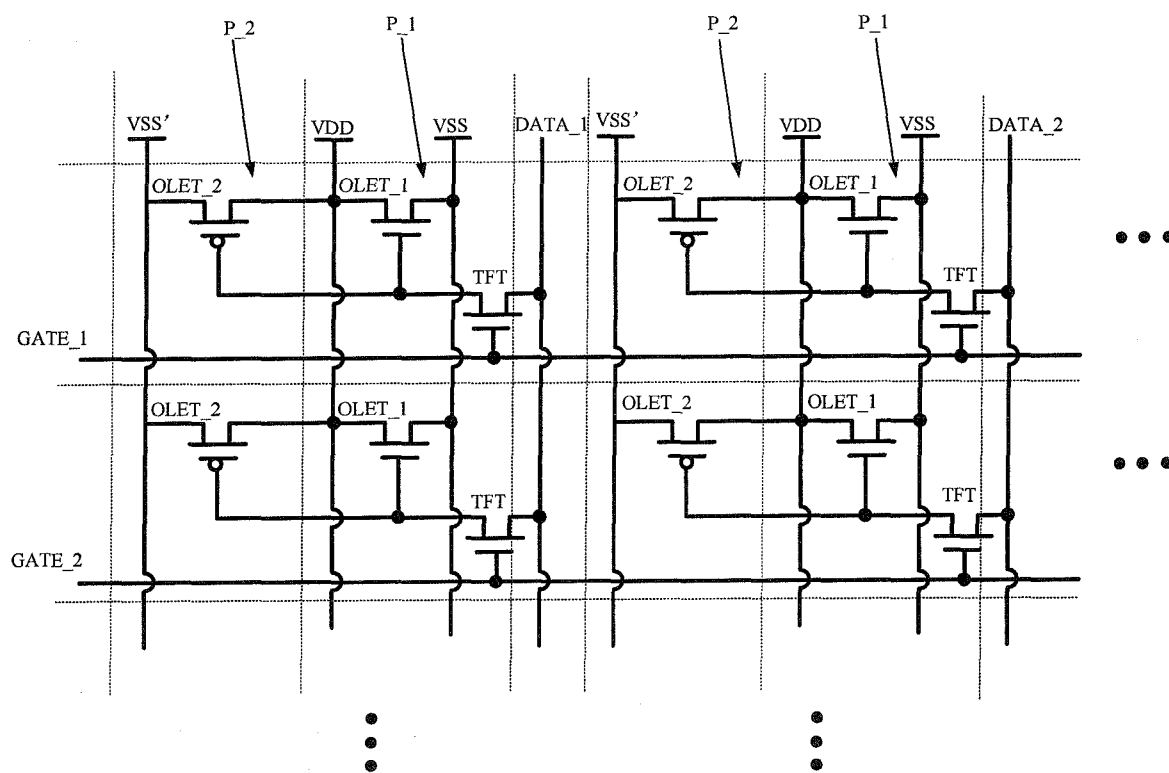


Fig.10

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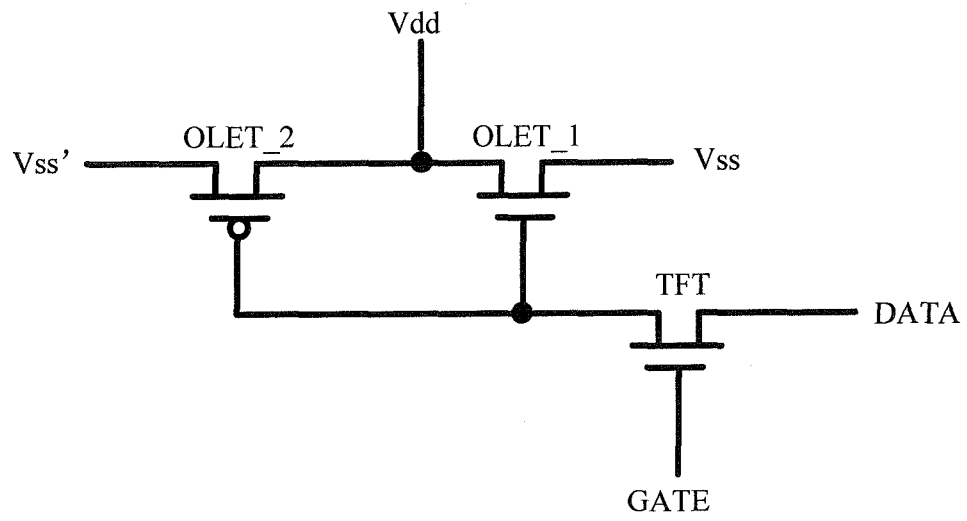


Fig. 11

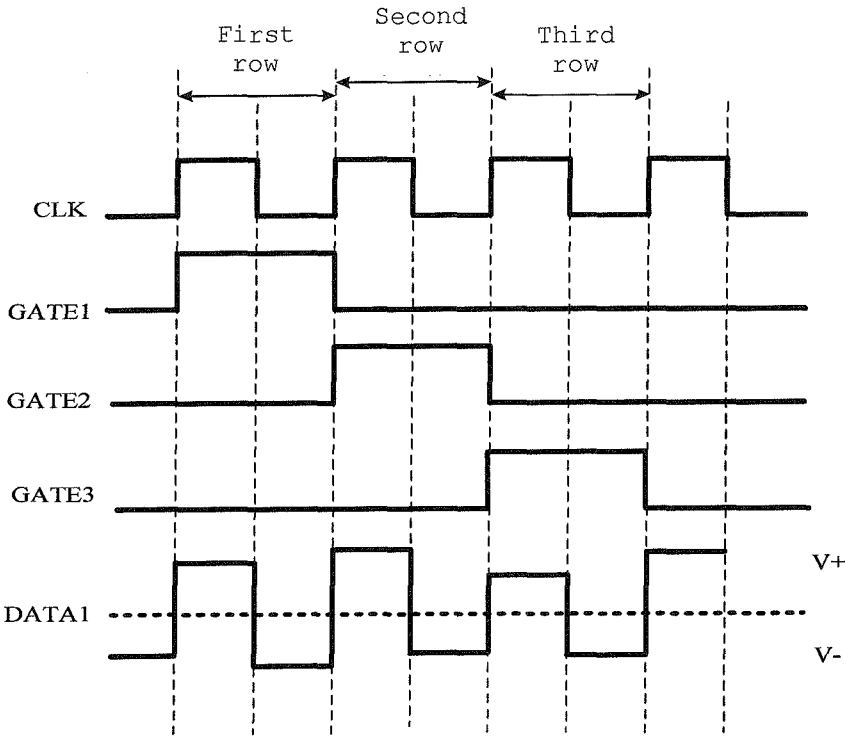


Fig. 12a

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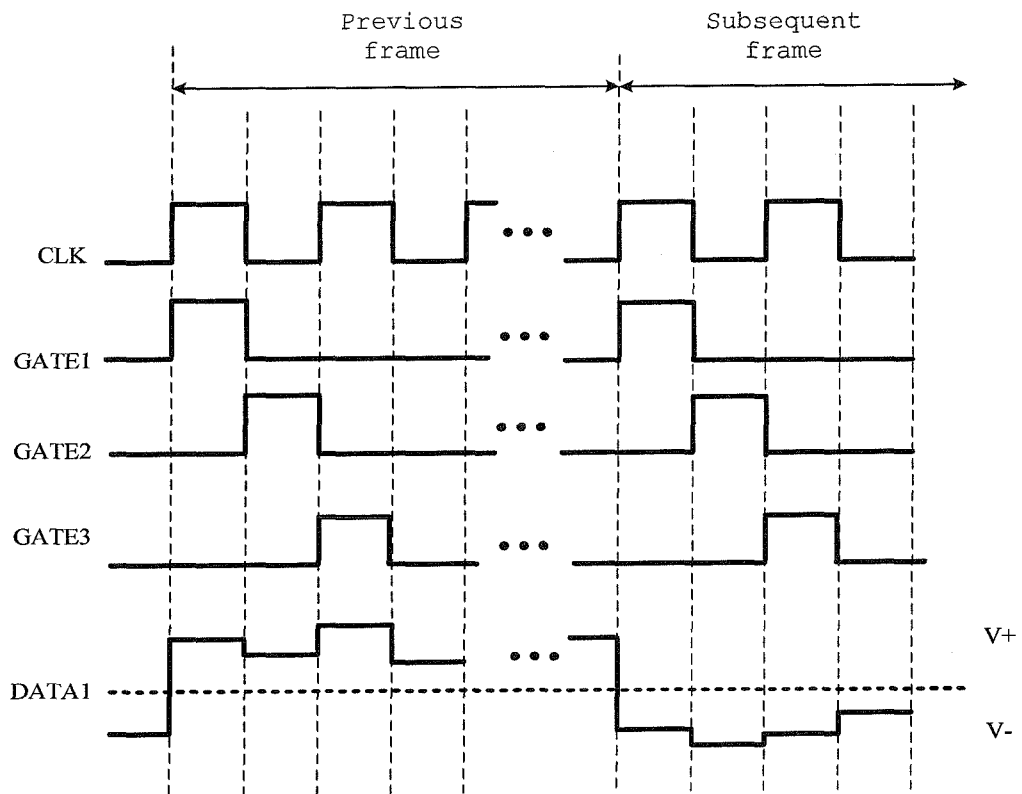


Fig. 12b

INTERNATIONAL SEARCH REPORT

International application No.

PCT/CN2018/116391

A. CLASSIFICATION OF SUBJECT MATTER

H01L 51/50(2006.01)i

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

H01L; H05B33

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

VEN;CNABS;CNTXT;CNKI:organic, light emitting, luminescent, transistor, olet, gate, first, second, connect, couple

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
Y	CN 1802054 A (SAMSUNG SDI CO LTD) 12 July 2006 (2006-07-12) description, page 4, line 27 to page 9, line 23, figures 1-13	1-21
Y	CN 107369651 A (BOE TECHNOLOGY GROUP CO LTD) 21 November 2017 (2017-11-21) description, paragraphs [0049]-[0051], figures 1-5	1-21
Y	CN 104678667 A (LG DISPLAY CO LTD) 03 June 2015 (2015-06-03) description, paragraph [0054], figure 2	1-21

☐ Further documents are listed in the continuation of Box C.☒ See patent family annex.

* Special categories of cited documents:

“A” document defining the general state of the art which is not considered to be of particular relevance

“E” earlier application or patent but published on or after the international filing date

“L” document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)

“O” document referring to an oral disclosure, use, exhibition or other means

“P” document published prior to the international filing date but later than the priority date claimed

“T” later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention

“X” document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone

“Y” document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art

“&” document member of the same patent family

Date of the actual completion of the international search

11 February 2019

Date of mailing of the international search report

20 February 2019

Name and mailing address of the ISA/CN

National Intellectual Property Administration, PRC
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Facsimile No. (86-10)62019451

Telephone No. 62089115

INTERNATIONAL SEARCH REPORT
Information on patent family members

International application No.

PCT/CN2018/116391

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				EP	1659647	B1	19 September 2007
				JP	2006148097	A	08 June 2006
				US	8182304	B2	22 May 2012
				JP	4652951	B2	16 March 2011
				EP	1659647	A1	24 May 2006
				US	2006103290	A1	18 May 2006
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				DE	602005002522	D1	31 October 2007
				US	2010291716	A1	18 November 2010
				US	7800300	B2	21 September 2010
				CN	100512583	C	08 July 2009
				DE	602005002522	T2	19 June 2008
				None			
CN	107369651	A	21 November 2017	None			
CN	104678667	A	03 June 2015	CN	107885003	A	06 April 2018
				CN	104678667	B	05 December 2017
				US	2015154899	A1	04 June 2015
				KR	20150063748	A	10 June 2015
				US	9159285	B2	13 October 2015